ROHM SEMICONDUCTOR

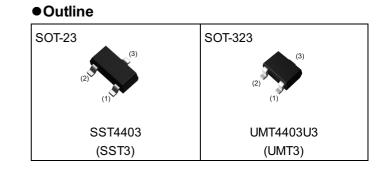
Parameter	Value
V _{CEO}	-40V
Ι _C	-600mA

Features

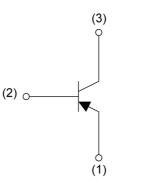
- 1)BV_{CEO}=-40V(Min.); at I_C=-1mA
- 2)Complements the SST4401/UMT4401U3

Application

AUDIO FREQUENCY SMALL SIGNAL AMPLIFIER



Inner circuit



(1) Emitter(2) Base(3) Collector

Packaging specifications

Part No.	Package	Package size	Taping code	Reel size (mm)	Tape width (mm)	Basic ordering unit.(pcs)	Marking
SST4403	SOT-23 (SST3)	2924	T116	180	8	3000	R2T
UMT4403U3	SOT-323 (UMT3)	2021	T106	180	8	3000	R2T

● Absolute maximum ratings (T_a = 25°C)

Parameter	Symbol	Values	Unit
Collector-base voltage	V _{CBO}	-40	V
Collector-emitter voltage	V _{CEO}	-40	V
Emitter-base voltage	V _{EBO}	-6	V
Collector current	Ι _C	-600	mA
	P _D ^{*1}	200	mW
Power dissipation	P _D *2	350	mW
Junction temperature	Tj	150	°C
Range of storage temperature	T _{stg}	-55 to +150	C°

• Electrical characteristics ($T_a = 25^{\circ}C$)

Paramatar	Parameter Symbol Conditions		Values			Unit
r ai ai i ielei			Min.	Тур.	Max.	Unit
Collector-base breakdown voltage	BV _{CBO}	Ι _C = -100μΑ	-40	-	-	V
Collector-emitter breakdown voltage	BV_{CEO}	I _C = -1mA	-40	-	-	V
Emitter-base breakdown voltage	BV_{EBO}	Ι _E = -100μΑ	-5	-	-	V
Collector cut-off current	I _{CBO}	V _{CB} = -35V	-	-	-100	nA
Emitter cut-off current	I _{EBO}	V _{EB} = -5V	-	-	-100	nA
Collector-emitter saturation voltage	V _{CE(sat)} 1	I _C = -150mA, I _B = -15mA	-	-	-400	mV
Collector-entitler saturation voltage	V _{CE(sat)} 2*3	I _C = -500mA, I _B = -50mA	-	-	-750	mV
Base-emitter saturation voltage	V _{BE(sat)} 1	I _C = -150mA, I _B = -15mA	-750	-	-950	mV
Dase-ennitien saturation voltage	V _{BE(sat)} 2*3	I _C = -500mA, I _B = -50mA	-	-	-1.3	V
	h _{FE} 1	V _{CE} = -1V, I _C = -100µA	30	-	-	-
	h _{FE} 2	V _{CE} = -1V, I _C = -1mA	60	-	-	-
DC current gain	h _{FE} 3	V _{CE} = -1V, I _C = -10mA	100	-	-	-
	h _{FE} 4	V _{CE} = -1V, I _C = -150mA	100	-	300	-
	$h_{FE}5^{*3}$	V _{CE} = -2V, I _C = -500mA	20	-	-	-
Output capacitance	C _{ob}	V _{CB} = -10V, I _E = 0A f = 100kHz	-	-	8.5	pF
Input capacitance	C _{ib}	V _{BE} = -0.5V, I _C = 0A f = 100kHz	-	-	30	pF
Transition frequency	f _T	V _{CE} = -10V, I _E = 20mA f = 100MHz	200	-	-	MHz
Delay time	t _d	V _{CC} ≃ -30V I _C = -150mA	-	-	15	ns
Rise time	t _r	$I_{B1} = -15 \text{mA}, R_L = 200\Omega$ See test circuit	-	-	20	ns
Storage time	t _{stg}	$V_{CC} \simeq -30V$ I _C = -150mA	-	-	225	ns
Fall time	t _f	$I_{B1} = -15mA$ $I_{B2} = 15mA$, $R_L = 200\Omega$ See test circuit	-	-	30	ns

*1 Each terminal mounted on a reference land.

*2 Mounted on a ceramic board(7.0×5.0×0.6mm).

*3 Pulsed



• Electrical characteristic curves ($T_a = 25^{\circ}C$)

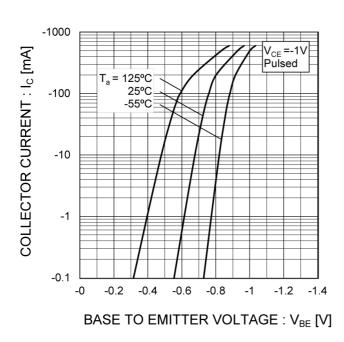


Fig.1 Ground Emitter Propagation Characteristics

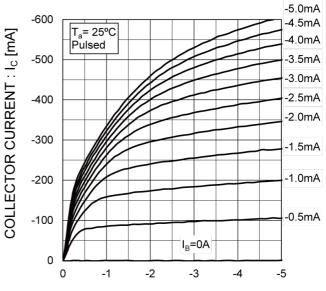


Fig.2 Typical Output Characteristics

COLLECTOR TO EMITTER VOLTAGE : V_{CE} [V]

Fig.3 DC Current Gain vs. Collector Current (I)

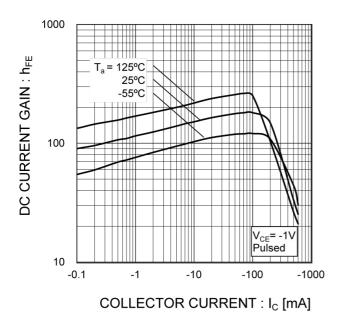
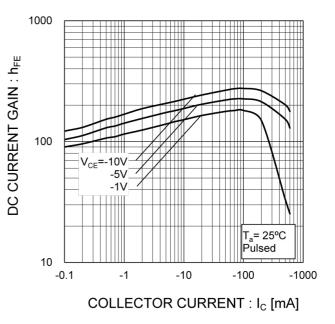


Fig.4 DC Current Gain vs. Collector Current (II)





• Electrical characteristic curves ($T_a = 25^{\circ}C$)

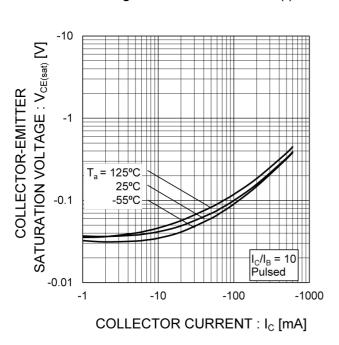
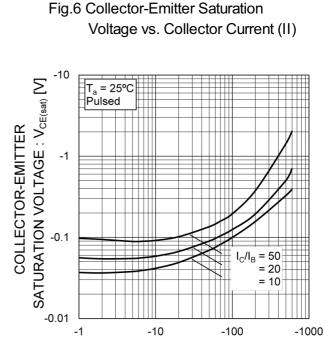


Fig.5 Collector-Emitter Saturation Voltage vs. Collector Current (I)



COLLECTOR CURRENT : I_C [mA]

Fig.7 Base-Emitter Saturation Voltage vs. Collector Current

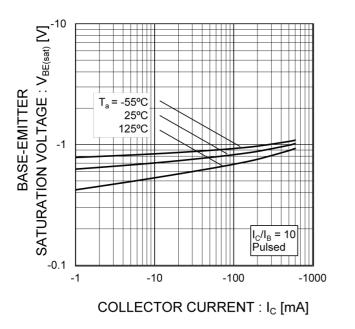
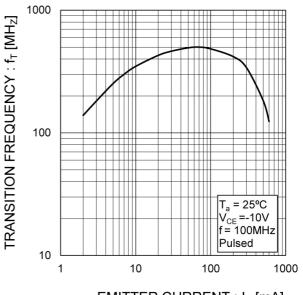


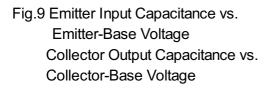
Fig.8 Gain Bandwidth Product vs. Emitter Current



EMITTER CURRENT : IE [mA]



• Electrical characteristic curves(T_a = 25°C)



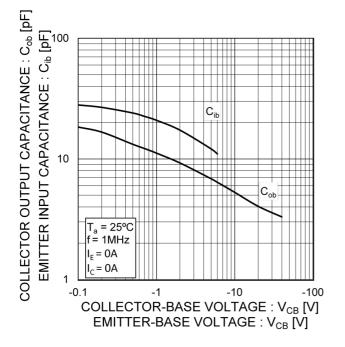
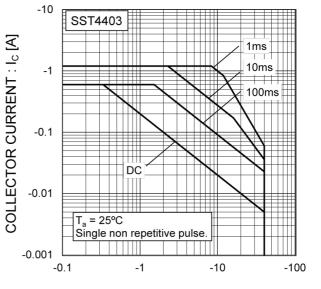
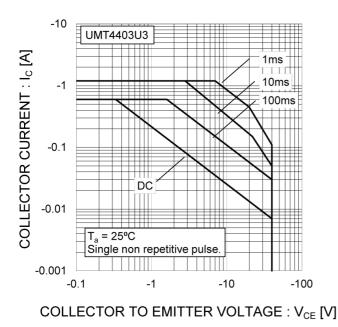


Fig.10 Safe Operating Area



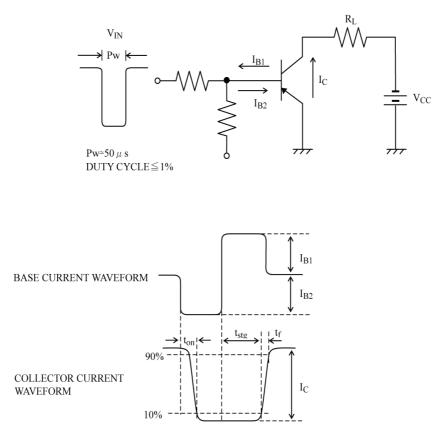
COLLECTOR TO EMITTER VOLTAGE : V_{CE} [V]

Fig.11 Safe Operating Area



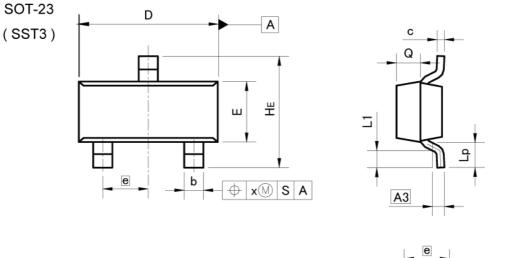


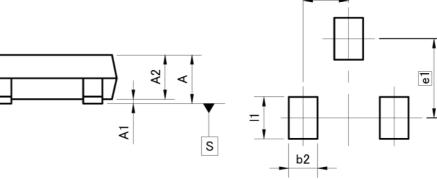
SWITCHING TIME TEST CIRCUIT





Dimensions





Pattern of terminal position areas [Not a pattern of soldering pads]

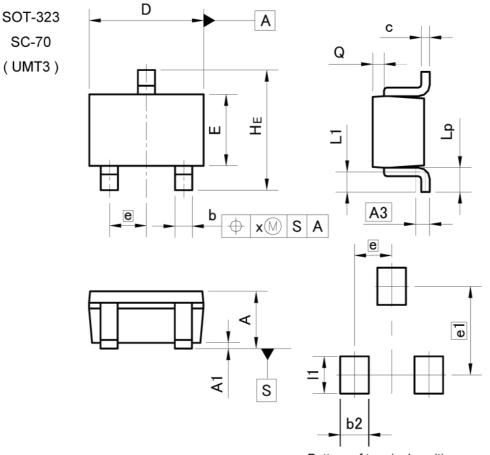
DIM	MILIMETERS		INCHES		
DIM	MIN	MAX	MIN	MAX	
A	0.90	1.20	0.035	0.047	
A1	0.00	0.10	0.000	0.004	
A2	0.85	1.15	0.033	0.045	
A3	0.1	25	0.0	10	
b	0.35	0.50	0.014	0.020	
с	0.09	0.25	0.004	0.010	
D	2.70	3.10	0.106	0.122	
E	1.20	1.50	0.047	0.059	
е	0.	95	0.037		
HE	2.20	2.60	0.087	0.102	
L1	0.20	-	0.008	-	
Lp	0.30	-	0.012	. –	
Q	0.40	0.60	0.016	0.024	
х	->	0.10	-	0.004	
	NATI TNA	TEDO	INC		

DIM	MILIM	ETERS	INCHES		
MIN		MAX	MIN	MAX	
b2	-	0.60	-	0.024	
e1	1.1	70	0.0	67	
1	- 0.90		-	0.035	

Dimension in mm/inches



Dimensions



Pattern of terminal position areas [Not a pattern of soldering pads]

DIM		INC	HES		
DIM	MIN	MAX	MIN	MAX	
A	0.80	1.00	0.031	0.039	
A1	0.00	0.10	0.000	0.004	
A3	0.3	25	0.010		
b	0.25	0.40	0.010	0.016	
С	0.10	0.20	0.004	0.008	
D	1.90	2.10	0.075	0.083	
E	1.15	1.35	0.045	0.053	
е	0.0	65	0.026		
HE	2.00	2.20	0.079	0.087	
L1	0.10	0.40	0.004	0.016	
Lp	0.25	0.55	0.010	0.022	
Q	0.10	0.30	0.004	0.012	
x	-	0.10	-	0.004	
DIM	MILIMETERS		INCHES		
DIM	MIN	MAX	MIN	MAX	
b2	-	0.50	-	0.020	
e1	1.55		0.061		
1	_	0.65	-	0.026	

Dimension in mm/inches



Notice

Precaution on using ROHM Products

1. Our Products are designed and manufactured for application in ordinary electronic equipment (such as AV equipment, OA equipment, telecommunication equipment, home electronic appliances, amusement equipment, etc.). If you intend to use our Products in devices requiring extremely high reliability (such as medical equipment (^{Note 1}), transport equipment, traffic equipment, aircraft/spacecraft, nuclear power controllers, fuel controllers, car equipment including car accessories, safety devices, etc.) and whose malfunction or failure may cause loss of human life, bodily injury or serious damage to property ("Specific Applications"), please consult with the ROHM sales representative in advance. Unless otherwise agreed in writing by ROHM in advance, ROHM shall not be in any way responsible or liable for any damages, expenses or losses incurred by you or third parties arising from the use of any ROHM's Products for Specific Applications.

JAPAN	USA	EU	CHINA	
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CLASSⅣ	CLASSⅢ	CLASSⅢ	CLASSII	

- 2. ROHM designs and manufactures its Products subject to strict quality control system. However, semiconductor products can fail or malfunction at a certain rate. Please be sure to implement, at your own responsibilities, adequate safety measures including but not limited to fail-safe design against the physical injury, damage to any property, which a failure or malfunction of our Products may cause. The following are examples of safety measures:
 - [a] Installation of protection circuits or other protective devices to improve system safety
 - [b] Installation of redundant circuits to reduce the impact of single or multiple circuit failure
- 3. Our Products are designed and manufactured for use under standard conditions and not under any special or extraordinary environments or conditions, as exemplified below. Accordingly, ROHM shall not be in any way responsible or liable for any damages, expenses or losses arising from the use of any ROHM's Products under any special or extraordinary environments or conditions. If you intend to use our Products under any special or extraordinary environments or conditions (as exemplified below), your independent verification and confirmation of product performance, reliability, etc, prior to use, must be necessary:
 - [a] Use of our Products in any types of liquid, including water, oils, chemicals, and organic solvents
 - [b] Use of our Products outdoors or in places where the Products are exposed to direct sunlight or dust
 - [c] Use of our Products in places where the Products are exposed to sea wind or corrosive gases, including Cl₂, H₂S, NH₃, SO₂, and NO₂
 - [d] Use of our Products in places where the Products are exposed to static electricity or electromagnetic waves
 - [e] Use of our Products in proximity to heat-producing components, plastic cords, or other flammable items
 - [f] Sealing or coating our Products with resin or other coating materials
 - [g] Use of our Products without cleaning residue of flux (Exclude cases where no-clean type fluxes is used. However, recommend sufficiently about the residue.); or Washing our Products by using water or water-soluble cleaning agents for cleaning residue after soldering
 - [h] Use of the Products in places subject to dew condensation
- 4. The Products are not subject to radiation-proof design.
- 5. Please verify and confirm characteristics of the final or mounted products in using the Products.
- 6. In particular, if a transient load (a large amount of load applied in a short period of time, such as pulse, is applied, confirmation of performance characteristics after on-board mounting is strongly recommended. Avoid applying power exceeding normal rated power; exceeding the power rating under steady-state loading condition may negatively affect product performance and reliability.
- 7. De-rate Power Dissipation depending on ambient temperature. When used in sealed area, confirm that it is the use in the range that does not exceed the maximum junction temperature.
- 8. Confirm that operation temperature is within the specified range described in the product specification.
- 9. ROHM shall not be in any way responsible or liable for failure induced under deviant condition from what is defined in this document.

Precaution for Mounting / Circuit board design

- 1. When a highly active halogenous (chlorine, bromine, etc.) flux is used, the residue of flux may negatively affect product performance and reliability.
- 2. In principle, the reflow soldering method must be used on a surface-mount products, the flow soldering method must be used on a through hole mount products. If the flow soldering method is preferred on a surface-mount products, please consult with the ROHM representative in advance.

For details, please refer to ROHM Mounting specification

Precautions Regarding Application Examples and External Circuits

- 1. If change is made to the constant of an external circuit, please allow a sufficient margin considering variations of the characteristics of the Products and external components, including transient characteristics, as well as static characteristics.
- 2. You agree that application notes, reference designs, and associated data and information contained in this document are presented only as guidance for Products use. Therefore, in case you use such information, you are solely responsible for it and you must exercise your own independent verification and judgment in the use of such information contained in this document. ROHM shall not be in any way responsible or liable for any damages, expenses or losses incurred by you or third parties arising from the use of such information.

Precaution for Electrostatic

This Product is electrostatic sensitive product, which may be damaged due to electrostatic discharge. Please take proper caution in your manufacturing process and storage so that voltage exceeding the Products maximum rating will not be applied to Products. Please take special care under dry condition (e.g. Grounding of human body / equipment / solder iron, isolation from charged objects, setting of lonizer, friction prevention and temperature / humidity control).

Precaution for Storage / Transportation

- 1. Product performance and soldered connections may deteriorate if the Products are stored in the places where:
 - [a] the Products are exposed to sea winds or corrosive gases, including Cl₂, H₂S, NH₃, SO₂, and NO₂
 - [b] the temperature or humidity exceeds those recommended by ROHM
 - [c] the Products are exposed to direct sunshine or condensation
 - [d] the Products are exposed to high Electrostatic
- 2. Even under ROHM recommended storage condition, solderability of products out of recommended storage time period may be degraded. It is strongly recommended to confirm solderability before using Products of which storage time is exceeding the recommended storage time period.
- 3. Store / transport cartons in the correct direction, which is indicated on a carton with a symbol. Otherwise bent leads may occur due to excessive stress applied when dropping of a carton.
- 4. Use Products within the specified time after opening a humidity barrier bag. Baking is required before using Products of which storage time is exceeding the recommended storage time period.

Precaution for Product Label

A two-dimensional barcode printed on ROHM Products label is for ROHM's internal use only.

Precaution for Disposition

When disposing Products please dispose them properly using an authorized industry waste company.

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